

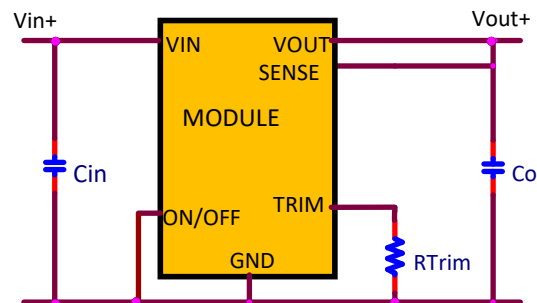
# IND045W Hornet: Non-Isolated DC-DC Voltage Regulator Modules

12Vdc input; 3Vdc to 8Vdc output; 34W Max Power



## Applications

- ✓ Industrial Equipment
- ✓ Control Boards
- ✓ Test Equipment



## Electrical Features

- 12V Input voltage with  $\pm 20\%$  Tolerance
- Output voltage programmable from 3Vdc to 8Vdc via external resistor
- Remote On/Off for optional external control
- Fixed switching frequency
- Output overcurrent protection (non-latching)

## Mechanical Features

- Small size: 20.3 mm x 11.4 mm x 8.5 mm (0.8 in x 0.45 in x 0.335 in)
- Operating range:  $-40^{\circ}\text{C}$  to  $105^{\circ}\text{C}$  ambient
- Operating shock to 40G per Mil Std. 810G, Method 516.4 Procedure I
- Operating vibration per Mil Std. 810G, Method 514.5 Procedure I

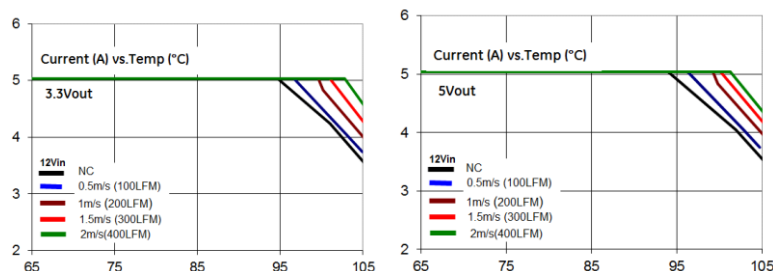
## Process and Safety

- Qualified for 1000h High Temperature Operating Bias, 1000h 85RH/ $85^{\circ}\text{C}$  Temperature, Humidity and Bias, 700 cycle  $-40$  to  $125^{\circ}\text{C}$  thermal cycling.
- ANSI/UL\* 62368-1 and CAN/CSA† C22.2 No. 62368-1 Recognized, DIN VDE‡ 0868-1/A11:2017 (EN62368-1:2014/A11:2017)
- ISO\*\* 9001 and ISO 14001 certified manufacturing facilities.
- Compliant to RoHS Directive 2011/65/EU and amended Directive (EU) 2015/863
- Compliant to REACH Directive (EC) No 1907/2006
- Compatible in a Pb-free or SnPb reflow environment.
- Suitable for aqueous clean.
- Suitable for conformal coating with dip and vapor deposition. Conformal coating can provide the protection to meet Salt Fog Test per IEC 60068-2-52 (Severity 3) and Mixed Gas Flow test per Telcordia GR-3108 Outdoor Levels.
- 3 year warranty.

| Device Code | Input Voltage | Output Voltage | Output Current (Max.) | On/Off Logic | Comcode     |
|-------------|---------------|----------------|-----------------------|--------------|-------------|
| IND045W     | 9.6 – 14.4Vdc | 3.0 – 8.0Vdc   | 5A(@3Vout)            | Negative     | 1600102903A |

## Thermal Performance

Full rated output with natural convection up to  $95^{\circ}\text{C}$  at 3.3Vout and up to  $94^{\circ}\text{C}$  at 5Vout.. Thermal curves for 2 voltages below.



## Electrical Specifications

| Parameter   | Device | Symbol      | Min                | Typ | Max  | Unit          |
|---|--------|-------------|--------------------|-----|------|---------------|
| Operating Input Voltage   | All    | $V_{IN}$    | 9.6                | 12  | 14.4 | Vdc           |
| External Capacitance, Ceramic ESR $\geq 1 \text{ m}\Omega$                            | All    | $C_{O,max}$ |                    | —   | 47*  | $\mu\text{F}$ |
| Efficiency 12V <sub>INDC</sub> , T <sub>A</sub> =25°C, I <sub>o</sub> as per Figure 2 |        | $\eta$      | 91(3.3V), 93.3(5V) |     |      | %             |
| Switching Frequency   | All    | $f_{sw}$    | —                  | 300 | —    | kHz           |
| Output Voltage (Over all line, load, and temperature conditions)                      | All    | $VO_{set}$  | -3.0               | —   | +3.0 | % $VO_{set}$  |
| On/Off Logic High (MODULE OFF) Input High Voltage                                     | All    | $V_{IH}$    | 1.5                | —   | 36   | Vdc           |
| On/ Off Logic Low (MODULE ON) Input Low Voltage                                       | All    | $V_{IL}$    | -0.2               | —   | 1    | Vdc           |

\*Additional External Capacitance possible using Tunable Loop

## Characteristic Curves

The following figures provide typical characteristics for the IND045W Hornet at 25°C.

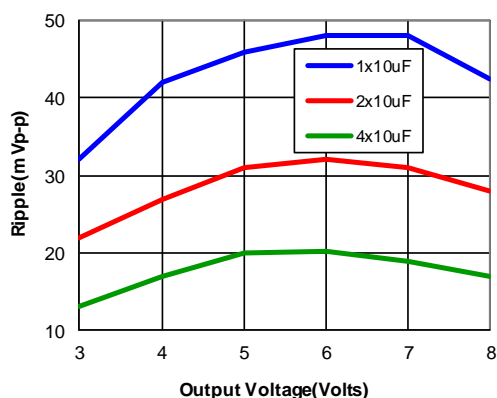


Figure 1. Output Ripple Voltage for various output voltages and external caps @12Vin. Additional Decoupling cap of 0.01uF used on input and output side

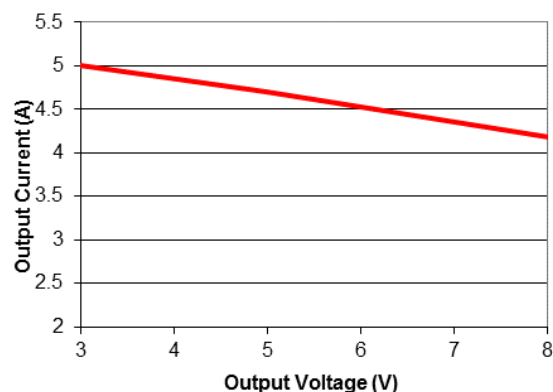


Figure 2. Graph showing maximum output current capability at different output voltages.

Use electrical profile in Figure 2 for determining baseline output current for a specific voltage. Then thermal curves.

## Trim

$R_{trim}$  for a desired output voltage, should be as per the following table. The formula in the last column helps determine  $R_{trim}$  for other voltages.

|                     |       |       |      |      |   |
|---------------------|-------|-------|------|------|---|
| $Vo$ (V)            | 3.3   | 5.0   | 6    | 8    | $R_{trim} = \left[ \frac{70}{(Vo - 0.7)} \right] k\Omega$ |
| $R_{trim}(k\Omega)$ | 26.92 | 16.27 | 13.2 | 9.59 |   |

## On/Off

On/Off pin must be connected to Ground. If the On/Off pin is left floating the module will be left in the OFF state.

## Safety Considerations

For safety agency approval, the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards listed on the first page of this document. For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV) or ES1, the input must meet SELV/ES1 requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV. The input to these units is to be provided with a fast-acting fuse with a maximum rating of 8A in the positive input lead.

## Tunable Loop

The module is designed for 200 $\mu$ F capacitor on its output. For applications where more than 200 $\mu$ F capacitors would be used on the output, an additional Resistor ( $R_{TUNE}$ ) and Capacitor ( $C_{TUNE}$ ) would be required in the circuit schematic to compensate for the additional capacitance. The placement is between the Sense+ pin and Trim pin as per figure below:

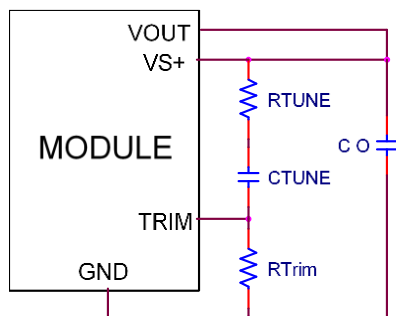


Figure. 3. Circuit diagram showing connection of  $R_{TUNE}$  and  $C_{TUNE}$  to tune the control loop of the module

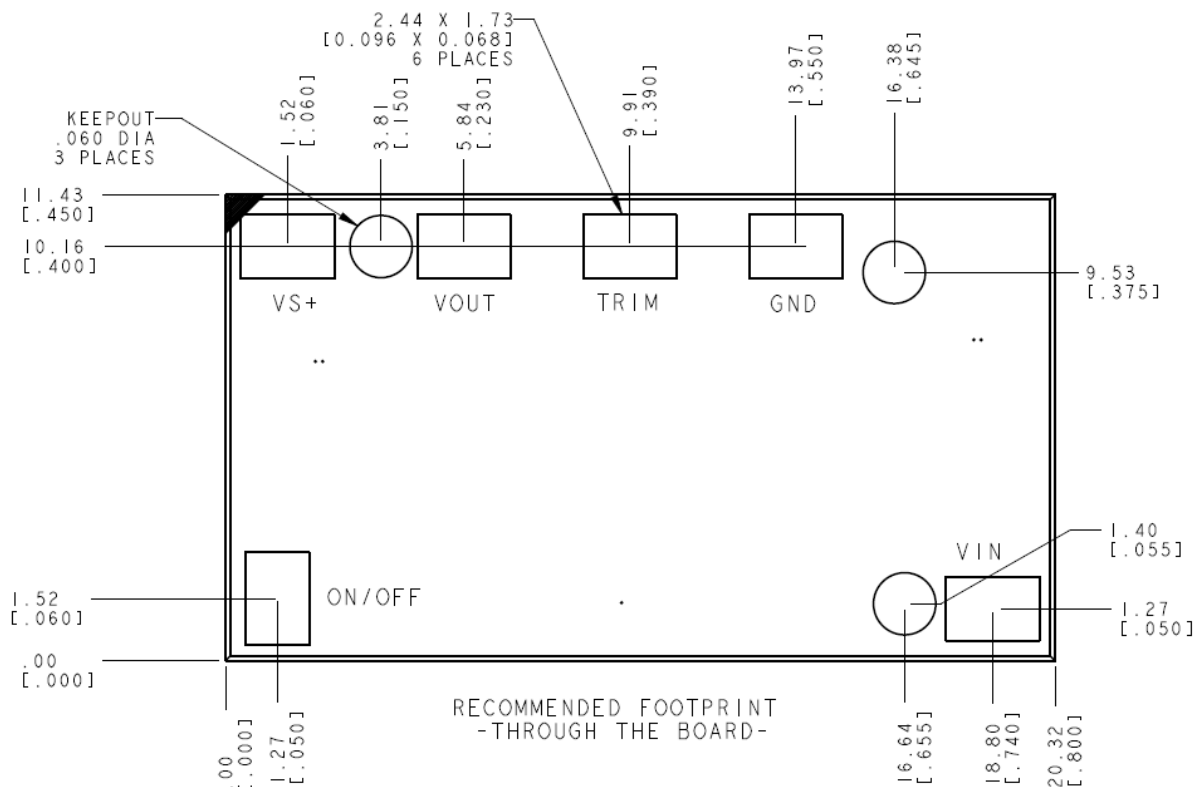
The recommended values for  $R_{TUNE}$  and  $C_{TUNE}$  for different amounts of external capacitance are as per the table below:

| Co         | 1x10 $\mu$ F | 1x22 $\mu$ F | 2x22 $\mu$ F | 4x22 $\mu$ F | 6x22 $\mu$ F |
|------------|--------------|--------------|--------------|--------------|--------------|
| $R_{TUNE}$ | 330 $\Omega$ | 270 $\Omega$ | 270 $\Omega$ | 220 $\Omega$ | 180 $\Omega$ |
| $C_{TUNE}$ | 680pF        | 1200pF       | 2700pF       | 4700pF       | 1.8nF        |

## Recommended Pad Layout

Dimensions are in millimeters and (inches).

Tolerances: x.x mm  $\pm$  0.5 mm (x.xx in.  $\pm$  0.02 in.) [unless otherwise indicated] x.xx mm  $\pm$  0.25 mm (x.xxx in  $\pm$  0.010 in.)



## Nozzle Recommendations

The minimum recommended inside nozzle diameter for reliable operation is 3mm. The maximum nozzle outer diameter, which will safely fit within the allowable component spacing, is 7 mm.

## Bottom Side / First Side Assembly

This module is not recommended for assembly on the bottom side of a customer board. If such an assembly is attempted, components may fall off the module during the second reflow process

## Lead Free Soldering

The modules are lead-free (Pb-free) and RoHS compliant and fully compatible in a Pb-free soldering process. Failure to observe the instructions below may result in the failure of or cause damage to the modules and can adversely affect long-term reliability

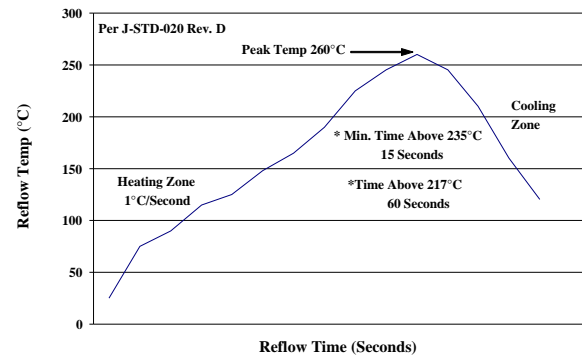
## MSL Rating

The modules have a MSL rating of 2a.

## Pb-free Reflow Profile

Power Systems will comply with J-STD-020 Rev. D (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. The suggested Pb-free solder paste is Sn/Ag/Cu (SAC).

The following profile is the recommended linear reflow profile using Sn/Ag/Cu solder. Soldering outside of the recommended profile requires testing to verify results and performance.



## Storage and Handling

J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices) is recommended. Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of  $\leq 30^{\circ}\text{C}$  and 60% relative humidity varies according to the MSL rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions:  $< 40^{\circ}\text{C}$ ,  $< 90\%$  relative humidity.

## Post Solder Cleaning and Drying Considerations

Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly

## Contact Us

For more information, call us at

USA/Canada:

**+1 888 546 3243**, or +1 972 244 9288

Asia-Pacific:

**+86-21-53899666**

Europe, Middle-East and Africa:

**+49.89.878067-280**

[Go.ABB/Industrial](http://Go.ABB/Industrial)



GE Critical Power reserves the right to make changes to the product(s) or information contained herein without notice, and no liability is assumed as a result of their use or application. No rights under any patent accompany the sale of any such product(s) or information.

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[OmniOn Power:](#)

[IND045W](#)